	U.S. PATENT DOCUMENTS									
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Examiner Initials*	Cite No.1	Number	Kind Code <sup>2</sup> (if known)	Name of Patentee or Applicant of Cited Document	Date of Publication of Cited Document MM-DD-YYYY					
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<sup>\*</sup>EXAMINER: Initial if reference considered, whether or not citation is in conformance with MPEP 609. Draw line through citation if not in conformance and not considered. Include copy of this form with next communication to applicant.

Signature

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<sup>&#</sup>x27;Unique citation designation number. 'See attached Kinds of U.S. Patent Documents. 'Enter Office that issued the document, by the two-letter code (WIPO Standard ST.3). 'For Japanese patent documents, the indication of the year of the reign of the Emperor must precede the serial number of the patent document. 'Kind of document by the appropriate symbols as indicated on the document under WIPO Standard ST. 16 if possible. 'Applicant is to place a check mark here if English language Translation is attached.'

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STA	TEME	NT BY	AP	PLICANT		C	onfirmation Number	45	91	
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							roup Art Unit	28		
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	15	5,968,2	64	<del></del>			lida et al.	•	10/19/1999	
<i>ટ્યા</i> <i>ટ્યા</i>	16	6,045,6					Park et al.		04/04/2000	
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535	22	EP	0 50	3 816	B1		Shin-Etsu Handotai Company	Ltd.	09/16/1992	
535	23	EP	0 50	04 837	A2		Shin-Etsu Handotai Company	Ltd.	09/23/1992	<u> </u>
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<u>द्ध</u>	25	EP	0.7	16 168	A1	Shin-Etsu Handotai Company		Ltd.	12/06/1996	
গ্ৰ্য্য	26	EP	0 7	47 513	A2	Shin-Etsu Handotai Company		Ltd.	12/11/1996	
535	27	EP	0 8	90 662	A1	Shinetsu Handotai KK			01/13/1999	<u> </u>
225	28	EP	0 9	09 840	A1		Shinetsu Handota KK		04/21/1999	<u> </u>
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<sup>\*</sup>EXAMINER: Initial if reference considered, whether or not citation is in conformance with MPEP 609. Draw line through chatton if not in conformance and not considered. Include copy of this form with next communication to applicant.

'Unique citation designation number. 2See attached Kinds of U.S. Patent Documents. Enter Office that Issued the document, by the two-letter code (WIPO Standard ST.3). 4For Japanese patent documents, the indication of the year of the reign of the Emperor must precede the serial number of the patent document. 4Kind of document by the appropriate symbols as indicated on the document under WIPO Standard ST. 16 if possible. 4Applicant is to place a check mark here if English language Translation is attached.

PTO/SB	198A		•	Complete if Known			
	JAN 0 9 200	- α ,		Application Number	09/972,608		
11	IF MATION	(DISC	CLOSURE	Filing Date	October 5, 2001		
3	INICIMENT	ST AP	PLICANI	Confirmation Number	4591		
(use	e as many she	ets as	s necessary)	First Named Inventor	Vladimir Voronkov et al.		
1				Group Art Unit	2812		
				Examiner Name	Unknown		
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<i>S</i> 33	34	JÞ	8-330316 (Pub. Hei 07-158458)		Sumitomo Sitix Corp.	12/13/1996	х
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<i>হ</i> ন্ত <b>্</b>	36	JP	HO 9-202690		Shin-Etsu Semiconductor K.K.	08/05/1997	×
535	37	ЧL	11-157995	Α	Sumitomo Sitix Corp.	06/15/1999	×
527	38	JP	11-180800	А	Shin-Etsu Handotai Company Ltd.	07/06/1999	×
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ટ્ટેટ	40	JP	11-199386	Α	Shin-Etsu Handotai Company Ltd.	07/27/1999	×
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द्भर	43	PCT	WO 98/45508		MEMC Electronic Materials Inc.	10/15/1998	
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<sup>\*</sup>EXAMINER: Initial if reference considered, whether or not citation is in conformance with MPEP 809. Draw line through citation if not in conformance and not considered. Include copy of this form with next communication to applicant.

<sup>&</sup>lt;sup>1</sup>Unique citation designation number. <sup>2</sup>See attached Kinds of U.S. Patent Documents. <sup>3</sup>Enter Office that issued the document, by the two-letter code (WIPO Standard ST.3). <sup>4</sup>For Japanese patent documents, the indication of the year of the reign of the Emperor must precede the serial number of the patent document. <sup>5</sup>Kind of document by the appropriate symbols as indicated on the document under WIPO Standard ST. 16 if possible. <sup>6</sup>Applicant is to place a check mark here if English language Translation is attached.

PTO/SB/	DAN ABC	8 2002 8		Compl	Compl te if Known			
		چن	2,1	Application Number	09/972,608			
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31	AIEWENI	DIAP	PLICANT	Confirmation Number	4591			
(use	as many sh	neets as	necessary)	First Named Inventor	Vladimir Voronkov et al.			
			•	Group Art Unit	2812			
				Examiner Name	Unknown			
Sheet	4	of	8	Attorney Docket No	985401/23401			

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222	48	PCT	WO 01/21864	A1	MEMC Electronic Materials Inc.	03/29/2001					
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555	50	UK	GB 2 137 524	А	Hitachi Ltd. (Japan)	10/10/1984					
535	51	UK	GB 2 182 262	Α	Sony Corp.	05/13/1987					
		ОТН	IER ART - NON	PATEN	T LITERATURE DOCUMEN	ITS					
Examiner Initials*	Cite No. <sup>1</sup>		Include name of the author (in CAPITAL LETTERS), title of the article (when appropriate), title of the item (book, magazine, journal, serial, symposium, catalog, etc.) date, page(s), volume-issue number(s), publisher, city and/or country where published.								
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\*EXAMINER: Initial if reference considered, whether or not citation is in conformance with MPEP 609. Draw line through ditation if not in conformance and not considered. Include copy of this form with next communication to applicant.

'Unique citation designation number. <sup>2</sup>See attached Kinds of U.S. Patent Documents. <sup>3</sup>Enter Office that issued the document, by the two-letter code (WIPO Standard ST.3). <sup>4</sup>For Japanese patent documents, the indication of the year of the reign of the Emperor must precede the serial number of the patent document. <sup>5</sup>Kind of document by the appropriate symbols as indicated on the document under WIPO Standard ST. 16 if possible. <sup>6</sup>Applicant is to place a check mark here if English language Translation is attached.

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	1,		9 2002	Application Number	09/972,608	
41	IFORMATION	DISC	LOSURE	Filing Date	October 5, 2001	
S	IAIEMENIB	Y PAT	PEICANT	Confirmation Number	4591	
(use	e as many shee	ets as	s necessary)	First Named Inventor	Vladimir Voronkov et al.	
				Group Art Unit	2812	
				Examiner Name	Unknown	
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<sup>&#</sup>x27;Unique citation designation number. <sup>2</sup>See attached Kinds of U.S. Patent Documents. <sup>3</sup>Enter Office that issued the document, by the two-letter code (WIPO Standard ST.3). <sup>4</sup>For Japanese patent documents, the indication of the year of the reign of the Emperor must precede the serial number of the patent document. <sup>6</sup>Kind of document by the appropriate symbols as indicated on the document under WIPO Standard ST. 16 if possible. <sup>6</sup>Applicant is to place a check mark here if English language Translation is attached.

PTO/SB/08A JAN 0 8 2002				Complete if Known		
				Application Number	09/972,608	
11	NFORMATIC	W.DIS	EOSURE	Filing Date	October 5, 2001	
STATEMENT BY APPLICANT				Confirmation Number	4591	
(use as many sheets as necessary)		First Named Inventor	Vladimir Voronkov et al.			
				Group Art Unit	2812	
				Examiner Name	Unknown	
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	Examiner Signature	Steph	Sti	Date Considered	12/15/2003
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PTO/SB/08A				Compl te if Known		
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INI	FORMATION ATEMENT B	DISC	LÓSURE	Filing Date	October 5, 2001	
ST	ATEMENT'S		PLICANT	Confirmation Number	4591	
(use as many sheets as necessary)			necessary)	First Named Inventor	Vladimir Voronkov et al.	
				Group Art Unit	2812	
				Examiner Name	Unknown	
Sheet	8	of	8	Attorney Docket No.	985401/23401	

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